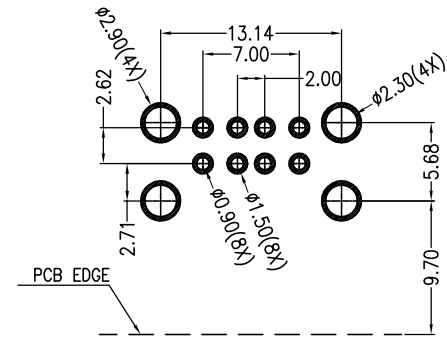
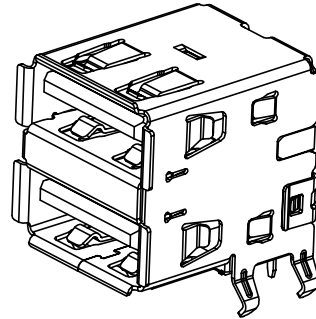
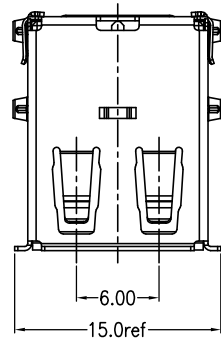
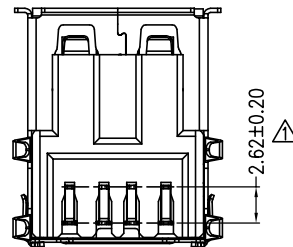
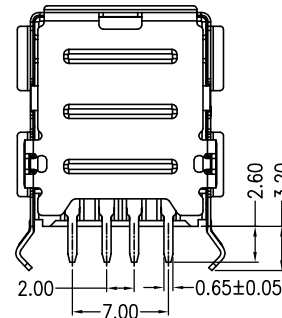
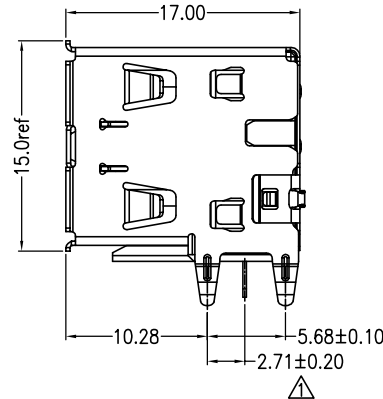
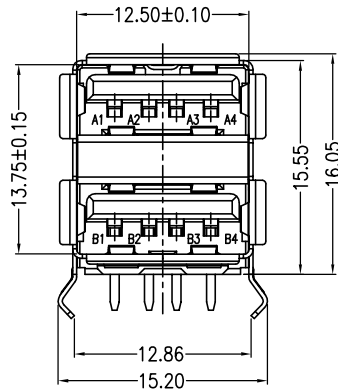


The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements



RECOMMENDED PCB LAYOUT (COMPONENT TOP VIEW)


P.C.B THICKNESS=1.20mm TOLERANCE:±0.05



A4	GND	B4	GND
A3	D+	B3	D+
A2	D-	B2	D-
A1	VBUS	B1	VBUS
Pin NO.	Signal name	Pin NO.	Signal name

NOTE:

- MATERIAL SPECIFICATION:
 - HOUSING:PBT BLACK UL94V-0
 - CONTACTS:C2680.
 - SHELL: SPCC
- PLATING SPECIFICATION:
 - CONTACTS:
 - UNDER PLATED OVER ALL.
 - WELDING AREA PLATED OVER ALL.
 - PLATED ON THE FUNCTIONAL AREA OF CONTACT.
 - SHELL:
 - Cu UNDER PLATED OVER ALL.
 - Ni WELDING AREA PLATED OVER ALL.
- MECHANICAL PERFORMANCE:
 - INSERTION FORCE: 3.57kgf MAX
 - REMOVAL FORCE: 1.02kgf MIN
 - DURABILITY: 1500 CYCLES.
- ELECTRICAL PERFORMANCE:
 - CURRENT RATING:1.5A
 - VOLTAGE RATING:30V MAX
 - CONTACT RESISTANCE: 30m Ohm MAX.
 - INSULATION RESISTANCE: 1000MΩ MIN
 - DIELECTRIC WITHSTANDING VOLTAGE: 500V AC MIN.
- ENVIRONMENTAL PERFORMANCE:
 - OPERATING TEMPERATURE: -20°C~+85°C.

REV.	REVISION RECORD	DATE	GENERAL TOLERANCES		SCALE:	NAME	DATE	PART.NO:	DWG.NO:	 WanLian Technology Co., Ltd
A0	NEW RELEASE	21.01.13	LINEAR	ANGLES	1:1	Wang_jr	21.01.13	WLU2F9-0811A1248	ENDE05	
A1	2.62±0.10 cha 2.62±0.2 2.71±0.25 cha 2.71±0.2	23.08.16	0.0±0.35	X'REF±6°	APPROVED	Ou_jian	21.01.13	TITLE: USB2.0 AF DOUBLE R/A DIP	REV: A1 SHEET: 1/1	
			0.00±0.25	X°±3°	DESIGNER	Hou-lanxuan	21.01.13			
			0.000±0.10	X°X' ±2°	DRAWN					
			UNIT: mm							